



**SBR3U60P1** 

# 3A SBR<sup>®</sup> SUPER BARRIER RECTIFIER POWERDI<sup>®</sup>

## **Product Summary**

V <sub>RRM</sub> (V)	Io (A)	V <sub>Fmax</sub> (V)	I <sub>R max</sub> (μΑ)	
60	3	0.65	100	

#### **Features and Benefits**

- Ultra Low Forward Voltage Drop
- Low reverse leakage current
- Patented Interlocking Clip Design for High Surge Current Capacity
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Description and Applications**

The SBR3U60P1 is a single rectifier in POWERDI123 package. Offering excellent high temperature stability and very low forward voltage, this device is ideal for use in the following applications.

- Bridge diodes
- Blocking diodes
- · Reverse protection diodes

## **Mechanical Data**

- Case: POWERDI123
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- · Polarity Indicator: Cathode Band
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.018 grams (approximate)

#### POWERDI123







Device symbol

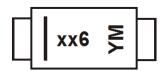
# Ordering Information (Note 4)

	<u> </u>	
Part Number	Case	Packaging
SBR3U60P1-7	POWERDI123	3000/Tape & Reel
SBR3U60P1-13	POWERDI123	10,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

# **Marking Information**



SV6, 3U6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)

M = Month (ex: 9 = September)

Date Code Key

Year	201	1	2012		2013	20	14	2015		2016	- 2	2017
Code	Υ		Z		Α	E	٦ I	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	60	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	42	V
Average Rectified Output Current (See Figure 1)	I <sub>O</sub>	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	80	Α
Repetitive Peak Avalanche Energy (1µs, +25°C)	PARM	2100	W

## **Thermal Characteristics**

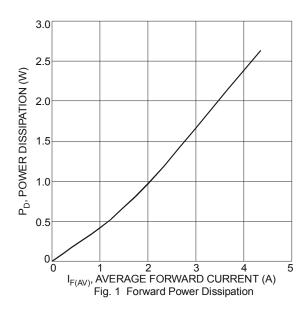
Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Soldering (Note 5)	$R_{\theta JS}$	5	°C/W
Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	175	C/VV
Operating and Storage Temperature Range (Note 7)	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

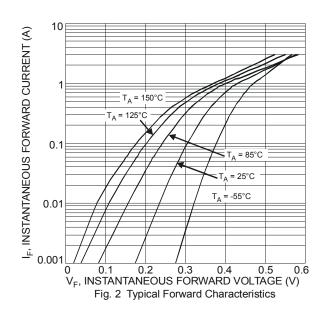
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	1	1	0.650	<b>V</b>	$I_F = 3.0A, T_J = +25^{\circ}C$
Leakage Current (Note 7)	I <sub>R</sub>	1	1	100	μΑ	V <sub>R</sub> = 60V, T <sub>J</sub> = +25°C

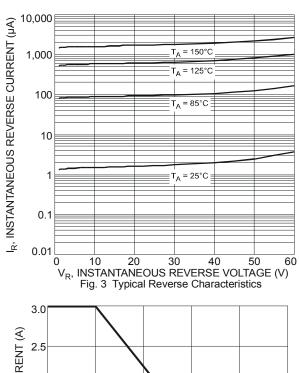
Notes:

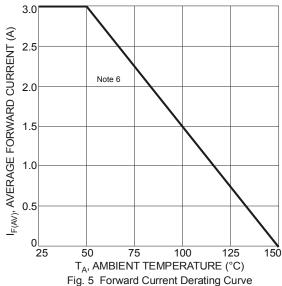
- 5. Theoretical R<sub>0JS</sub> calculated from the top center of the die straight down to the PCB cathode tab solder junction.
- 6. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
  7. Short duration pulse test used to minimize self-heating effect.











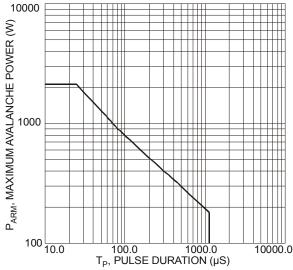
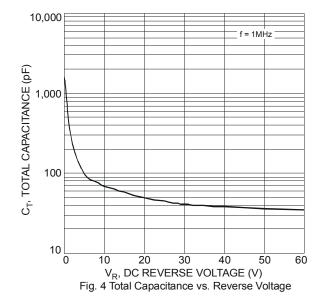
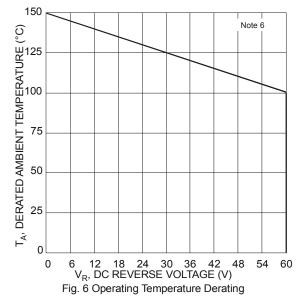


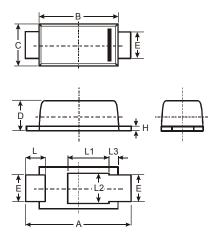
Fig. 7 Maximum Avalanche Power Curve, Per Element





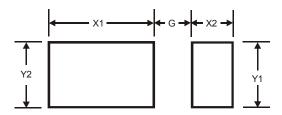


# **Package Outline Dimensions**



POWERDI123						
Dim	Min	Max	Тур			
Α	3.50	3.90	3.70			
В	2.60	3.00	2.80			
С	1.63	1.93	1.78			
D	0.93	1.00	0.98			
Е	0.85	1.25	1.00			
Н	0.15	0.25	0.20			
L	0.40	0.50	0.45			
L1	ı	ı	1.35			
L2	-	-	1.10			
L3	-	-	0.20			
All Dimensions in mm						

# **Suggested Pad Layout**



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4



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